

MAXIMUM RATINGS

Rating	Symbol	Value		Unit
Collector-Emitter Voltage	V_{CEO}	40		Vdc
Collector-Base Voltage	V_{CBO}	50		Vdc
Emitter-Base Voltage	V_{EBO}	5.0		Vdc
Collector Current — Continuous	I_C	30		mAdc
		One Die	Both Die Equal Power	
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	575 3.29	625 3.57	mW mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.8 10.3	2.5 14.3	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200		$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	One Die	Both Die Equal Power	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	97	70	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}(1)$	304	280	$^\circ\text{C}/\text{W}$
		Junction to Ambient	Junction to Case	%
Coupling Factors		84	44	%

(1) $R_{\theta JA}$ is measured with the device soldered into a typical printed circuit board.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage(2) ($I_C = 10 \text{ mAdc}, I_B = 0$)	$V_{(BR)CEO}$	40	—	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 10 \mu\text{Adc}, I_E = 0$)	$V_{(BR)CBO}$	50	—	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 10 \mu\text{Adc}, I_C = 0$)	$V_{(BR)EBO}$	5.0	—	—	Vdc
Collector Cutoff Current ($V_{CB} = 30 \text{ Vdc}, I_E = 0$)	I_{CBO}	—	—	100	nAdc

ON CHARACTERISTICS

DC Current Gain(2) ($I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$)	h_{FE}	40 50	130 170	—	—
Collector-Emitter Saturation Voltage ($I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc}$)	$V_{CE(sat)}$	—	0.2	0.35	Vdc
Base-Emitter Saturation Voltage ($I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc}$)	$V_{BE(sat)}$	—	0.8	1.0	Vdc

SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product(2) ($I_C = 5.0 \text{ mAdc}, V_{CE} = 20 \text{ Vdc}, f = 100 \text{ MHz}$)	f_T	200	260	—	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 100 \text{ kHz}$)	C_{obo}	—	2.6	6.0	pF
Input Capacitance ($V_{BE} = 2.0 \text{ Vdc}, I_C = 0, f = 100 \text{ kHz}$)	C_{ibo}	—	2.3	8.0	pF

MATCHING CHARACTERISTICS

DC Current Gain Ratio(3) ($I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}$)	MD7002A MD7002B	h_{FE1}/h_{FE2}	0.75 0.85	— —	1.0 1.0	—
Base-Emitter Voltage Differential ($I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}$)	MD7002A MD7002B	$ V_{BE1} - V_{BE2} $	— —	— —	25 15	mVdc

(2) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

(3) The lowest h_{FE} reading is taken as h_{FE1} for this ratio.

MD7002,A,B

CASE 654-07, STYLE 1

DUAL
AMPLIFIER TRANSISTOR

NPN SILICON

Refer to 2N2919 for graphs.